

**IEEE 802.3 - Attendance and Affiliation Sheet**

Austin, TX, USA - February 2015

<b>Name</b>	<b>Employer</b>	<b>Affiliation</b>	<b>Mon</b>	<b>Wed</b>	<b>Credit</b>
Amason, Dale	Freescale Semiconductor, Inc.	Freescale Semiconductor, Inc.	1	1	2
Babenko, Oleksandr	Molex Incorporated	Molex Incorporated	1	1	2
Berglund, Victor		Vitesse Semiconductor Corporation	1		1
Brown, Thomas	Vitesse Semiconductor	Vitesse Semiconductor Corporation	1		1
Carlson, Steven	High-Speed Design Inc.	Broadcom Corporation	1	1	2
Chadha, Mandeep	Vitesse Semiconductor Corporation	Vitesse Semiconductor Corporation	1	1	2
Chen, Yencheng	Broadcom Corporation	Broadcom Corporation	1	1	2
Chini, Ahmad	Broadcom	broadcom	1	1	2
Donahue, Curtis	University of New Hampshire InterO	UNH-IOL		1	1
Graba, James	Broadcom Corporation	Broadcom Corporation	1		1
Hamidi, Seyed	Broadcom Corporation	Broadcom Corporation	1	1	2
Joseph, Antony	NXP Semiconductors	NXP Semiconductors	1	1	2
Law, David	Hewlett-Packard Ltd	Hewlett-Packard Ltd		1	1
Lo, William	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1		1
Matola, Laurence	Delphi Corporation	Delphi Corporation	1	1	2
Mcclellan, Brett	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1		1
Regev, Alon	Ixia	Ixia	1	1	2
Tu, Mike	Broadcom Corporation	Broadcom Corporation	1		1
Yurko, Garold	TE Connectivity	TE Connectivity	1	1	2